

MOS FIELD EFFECT TRANSISTOR 2SJ492

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is P-Channel MOS Field Effect Transistor designed for DC/DC converters and motor/lamp driver circuits.

ORDERING INFORMATION

| PART NUMBER | PACKAGE |
|-------------|----------|
| 2SJ492 | TO-220AB |
| 2SJ492-S | TO-262 |
| 2SJ492-ZJ | TO-263 |

FEATURES

- Low on-state resistance $R_{DS(on)1} = 100 \text{ m}\Omega \text{ (MAX.)} (V_{GS} = -10 \text{ V}, I_D = -10 \text{ A})$ $R_{DS(on)2} = 185 \text{ m}\Omega \text{ (MAX.)} (V_{GS} = -4 \text{ V}, I_D = -10 \text{ A})$
- Low Ciss: Ciss = 1210 pF (TYP.)
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| VDSS | -60 | V |
|----------|---|--|
| VGSS(AC) | ∓ 20 | V |
| VGSS(DC) | -20, 0 | V |
| D(DC) | ∓ 20 | А |
| D(pulse) | ∓ 80 | А |
| Р⊤ | 1.5 | W |
| Рт | 70 | W |
| Tch | 150 | °C |
| Tstg | –55 to +150 | °C |
| AS | -20 | А |
| Eas | 40 | mJ |
| | VGSS(AC) VGSS(DC) ID(DC) ID(pulse) PT PT Tch Tstg IAS | VGSS(AC) ∓ 20 VGSS(DC) −20, 0 ID(DC) ∓ 20 ID(pulse) ∓ 80 PT 1.5 PT 70 Tch 150 Tstg −55 to +150 IAS −20 |

Notes 1. f = 20 kHz, Duty Cycle $\leq 10\%$ (+Side)

- **2.** PW \leq 10 μ s, Duty Cycle \leq 1 %
- 3. Starting T_{ch} = 25 °C, R_A = 25 Ω , V_{GS} = -20 V \rightarrow 0

THERMAL RESISTANCE

| Channel to Case | Rth(ch-C) | 1.79 | °C/W |
|--------------------|-----------|------|------|
| Channel to Ambient | Rth(ch-A) | 83.3 | °C/W |

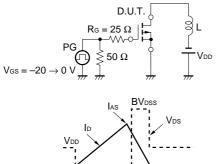
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ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

NEC

| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|-----------------|---|------|------|-------------|------|
| Drain to Source On-state Resistance | RDS(on)1 | $V_{GS} = -10 V$, $I_D = -10 A$ | | 70 | 100 | mΩ |
| | RDS(on)2 | $V_{GS} = -4 V$, $I_D = -10 A$ | | 120 | 185 | mΩ |
| Gate to Source Cut-off Voltage | VGS(off) | $V_{DS} = -10 V$, $I_D = -1 mA$ | -1.0 | -1.5 | -2.0 | V |
| Forward Transfer Admittance | y _{fs} | $V_{DS} = -10 \text{ V}, \text{ Id} = -10 \text{ A}$ | 5.0 | 12 | | S |
| Drain Leakage Current | IDSS | $V_{DS} = -60 V, V_{GS} = 0 V$ | | | -10 | μA |
| Gate to Source Leakage Current | lgss | $V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ | | | ∓ 10 | μA |
| Input Capacitance | Ciss | V _{DS} = -10 V | | 1210 | | pF |
| Output Capacitance | Coss | Vgs = 0 V | | 520 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 180 | | pF |
| Turn-on Delay Time | td(on) | ID = -10 A | | 16 | | ns |
| Rise Time | tr | $V_{GS(on)} = -10 V$ | | 140 | | ns |
| Turn-off Delay Time | td(off) | $V_{DD} = -30 V$ | | 90 | | ns |
| Fall Time | tr | R _G = 10 Ω | | 80 | | ns |
| Total Gate Charge | QG | ID = -20 A | | 42 | | nC |
| Gate to Source Charge | Q _{GS} | $V_{DD} = -48 V$ | | 8.0 | | nC |
| Gate to Drain Charge | Qgd | Vgs = -10 V | | 10 | | nC |
| Body Diode Forward Voltage | VF(S-D) | $I_F = -20 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$ | | 1.0 | | V |
| Reverse Recovery Time | trr | IF = -20 A, VGS = 0 V | | 125 | | ns |
| Reverse Recovery Charge | Qrr | di/dt = 50 A/ μ s | | 280 | | nC |

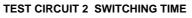
TEST CIRCUIT 1 AVALANCHE CAPABILITY

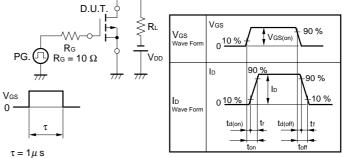


Starting Tch

TEST CIRCUIT 3 GATE CHARGE

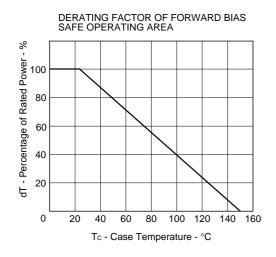
 $PG. \bigoplus_{m} \underbrace{50 \Omega}_{m} \underbrace{50 \Omega}_{m}$



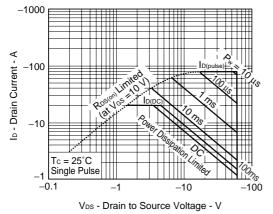


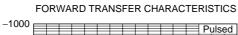
Duty Cycle $\leq 1 \%$

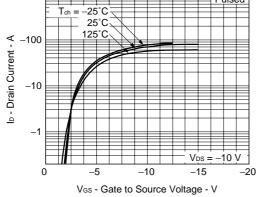
TYPICAL CHARACTERISTICS (TA = 25 °C)

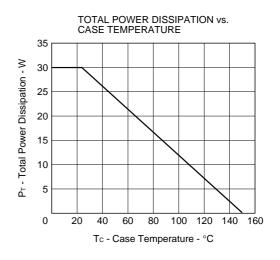


FORWARD BIAS SAFE OPERATING AREA

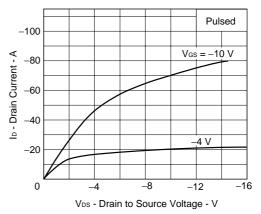


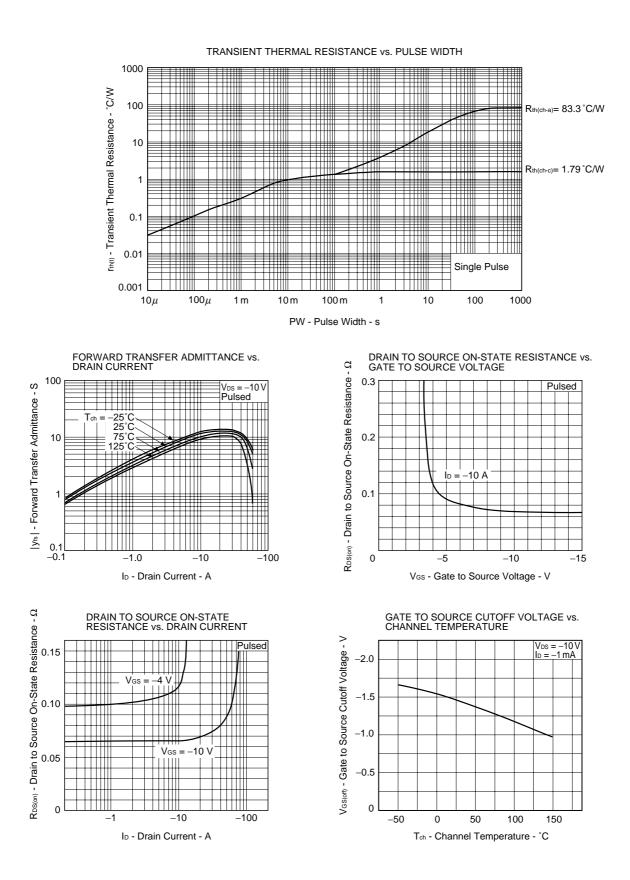


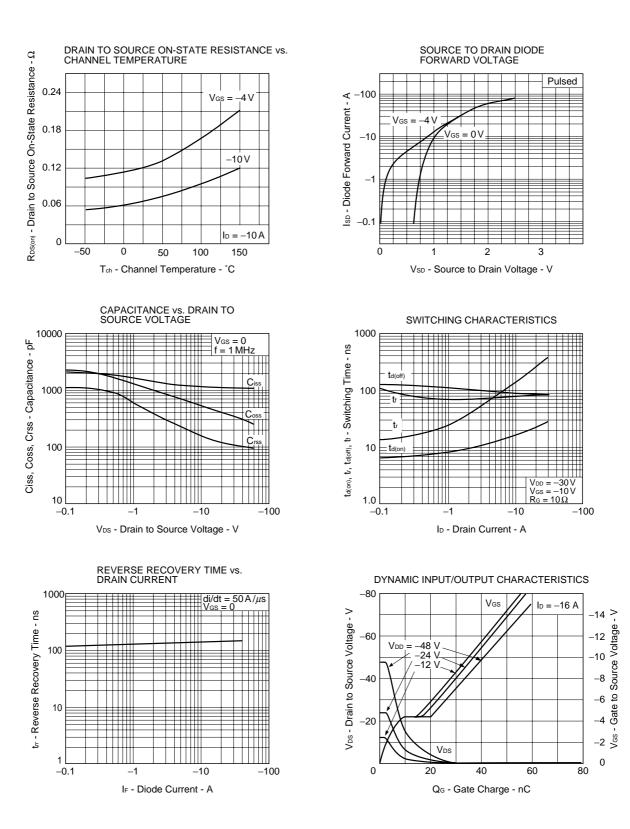




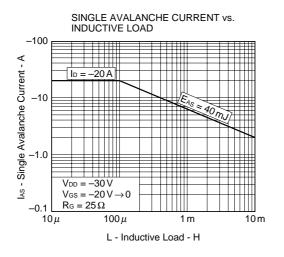




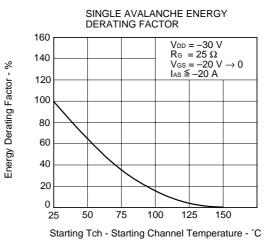




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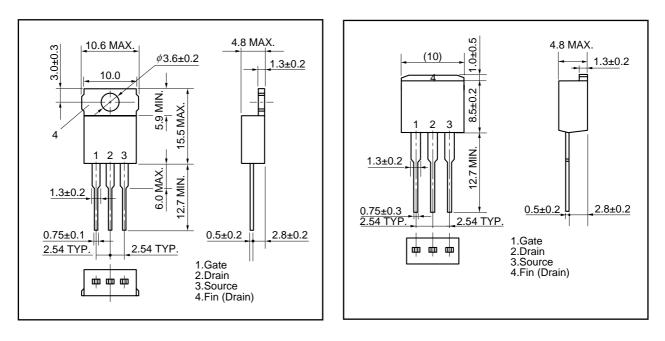
NEC



Data Sheet D11264EJ1V0DS00

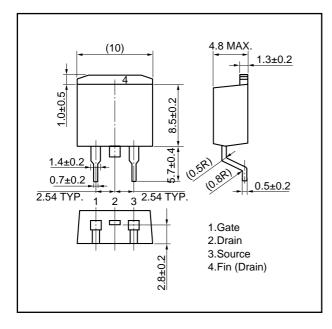
PACKAGE DRAWING (Unit: mm)

1) TO-220AB (MP-25)

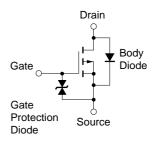


2) TO-262 (MP-25 Fin Cut)

3) TO-263 (JEDEC TYPE: MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.